

# 2018-2023 Global and Regional 5G Chipset Industry Production, Sales and Consumption Status and Prospects Professional Market Research Report

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# **Abstracts**

HNY Research projects that the 5G Chipset market size will grow from in 2017 to by 2023, at an estimated CAGR of. The base year considered for the study is 2017, and the market size is projected from 2018 to 2023.

The major driver for the growth of this market is the growing demand for high-speed internet and broad network coverage with reduced latency and power consumption. Moreover, increasing M2M/IoT connections and increasing demand for mobile data services are propelling the market growth.

By Market Players:

Qualcomm Technologies, Intel, Nokia, Samsung Electronics, Xilinx, IBM, Qorvo, Infineon Technologies, Integrated Device Technology, Anokiwave, Analog Devices, Broadcom, Huawei Technologies, Macom Technology Solutions, Cavium, Ericsson, Fujitsu, ZTE Corporation, Hewlett Packard Enterprise, Korea Telecom

By IC Type RFIC, ASIC, Cellular IC, mmWave IC

By Operation Frequency Sub-6 GHz, Between 26 and 39 GHz, Above 39 GHz

By Product

Devices, Customer Premises Equipment, Network Infrastructure Equipment



# By End-User Industry

Automotive & Transportation, Energy & Utilities, Healthcare, Retail, Building Automation, Industrial Automation, Consumer Electronics, Public Safety & Surveillance,

The prime objective of this report is to help the user understand the market in terms of its definition, segmentation, market potential, influential trends, and the challenges that the market is facing. Deep researches and analysis were done during the preparation of the report. The readers will find this report very helpful in understanding the market in depth. The data and the information regarding the market are taken from reliable sources such as websites, annual reports of the companies, journals, and others and were checked and validated by the industry experts. The facts and data are represented in the report using diagrams, graphs, pie charts, and other pictorial representations. This enhances the visual representation and also helps in understanding the facts much better.

# Points Covered in The Report:

The points that are discussed within the report are the major market players that are involved in the market such as manufacturers, raw material suppliers, equipment suppliers, end users, traders, distributors and etc.

The complete profile of the companies is mentioned. And the capacity, production, price, revenue, cost, gross, gross margin, sales volume, sales revenue, consumption, growth rate, import, export, supply, future strategies, and the technological developments that they are making are also included within the report. The historical data from 2012 to 2017 and forecast data from 2018 to 2023.

The growth factors of the market is discussed in detail wherein the different end users of the market are explained in detail.

Data and information by manufacturer, by region, by type, by application and etc, and custom research can be added according to specific requirements.

The report contains the SWOT analysis of the market. Finally, the report contains the conclusion part where the opinions of the industrial experts are included.

#### Key Reasons to Purchase

To gain insightful analyses of the market and have comprehensive understanding of the global market and its commercial landscape.

Assess the production processes, major issues, and solutions to mitigate the development risk.

To understand the most affecting driving and restraining forces in the market and its



impact in the global market.

Learn about the market strategies that are being adopted by leading respective organizations.

To understand the future outlook and prospects for the market.

Besides the standard structure reports, we also provide custom research according to specific requirements.



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